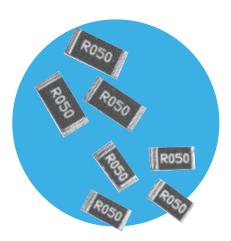
### **Resistors**

# **Electro**

## **Low Value Flat Chip Resistor**

### **LR Series**

- Standard 2512, 2010 and 1206 sizes
- Resistance values down to 0.003 ohms
- Leach resistant solder-plated copper wrap-around termination
- AEC-Q200 Qualified
- RoHS compliant and SnPb variants





All Pb-free parts comply with EU Directive 2011/65/EU (RoHS2)

### **Electrical Data**

		LR1206	LR2010	LR2512			
Power rating @70°C	watts	0.5 1 2					
Resistance range <sup>1</sup>	ohms	R003 to 1R0					
Resistance tolerance <sup>1</sup>	%	<r01: 1,="" 2,="" 5,="" 5<="" td="" ≥r01:=""></r01:>					
TCR	ppm/°C	≥R05: ±100, R025–R047: <+200, R015-R024: <+300, R01-R014: <+500, <r01: <+900<="" td=""></r01:>					
Dielectric withstand	volts	200					
Ambient temperature range	°C	-55 to +150					
Values		E24 preferred <sup>2</sup>					
Temperature rise at rated power	°C	40 80 90					
Pad / trace area <sup>3</sup>	mm²	<sup>2</sup> 30 100 300					

Note 1: Contact factory for value – tolerance combinations outside this range. Note 2: Many values = N x R001 and N x R005 up to N=10 are also available. Note 3: Recommended minimum pad & adjacent trace area for each termination for rated dissipation on FR4 PCB

### Physical Data

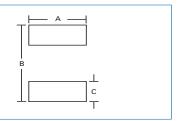
Dimensions (mm)				
Size	L	W	H (max)	D
LR1206	3.20±0.305	1.63±0.20	0.8	0.48±0.25
LR2010	5.23±0.38	2.64±0.25	0.84	0.48±0.25
LR2512	6.50±0.38	3.25±0.25	0.84	0.48±0.25
	H			
	<b>►D</b> -		Solder Plating Nickel Barrier Layer	

Recommended Solder Pad Dimensions (mm)							
	А	В	С				
LR1206	2.0	4.0	1.25				
LR2010	3.05	6.5	1.5				
LR2512	3.7	7.75	1.5				

Protective Overcoat/

Resistive Element

Copper Termination



TT Electronics reserves the right to make changes in product specification without notice or liability. All information is subject to TT Electronics' own data and is considered accurate at time of going to print.



Copper Wraparound

Termination

Alumina Substrate

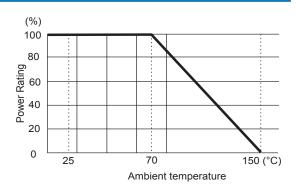


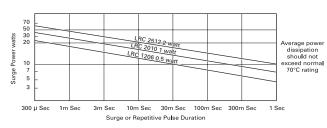
### **Low Value Flat Chip Resistor**





	AEC-Q200 Table 7	Method	Ма	<b>Typ.</b> (@1R0)	
ref	Test		(add f		
3	High Temp. Exposure	MIL-STD-202 Method 108	∆R%	0.5	0.2
4	Temperature Cycling	JESD22 Method JA-104	∆R%	0.25	0.1
6	Moisture Resistance	MIL-STD-202 Method 106	ΔR%	0.5	0.2
7	Biased Humidity	MIL-STD-202 Method 103	∆R%	0.5	0.2
8	Operational Life (Cyclic Load)	MIL-STD-202 Method 108	ΔR%	1	0.5
14	Vibration	MIL-STD-202 Method 204	ΔR%	0.5	0.05
15	Resistance to Soldering Heat	MIL-STD-202 Method 210	<b>∆</b> R%	0.25	0.05
16	Thermal Shock	MIL-STD-202 Method 107	ΔR%	0.25	0.1
18	Solderability	J-STD-002	>95%	erage	
21	Board Flex	AEC-Q200-005	∆R%	0.5	0.2
22	Terminal Strength	AEC-Q200-006	ΔR%	0.25	0.1
Short Term Overload		6.25 x Pr for 2s	∆R%	0.5	
[	Low Temperature Storage	-65°C for 100 hours	<b>∆</b> R%	0.5	
	Leach Resistance	Solder dip at 250°C	90s	minin	num





### Note:

- 1. Although 2010 and 2512 sizes have passed temperature cycling and thermal shock, it is in general not recommended that ceramic chips this large be used on FR4 in a severe temperature cycle environment due to the possibility of solder joint fatigue.
- 2. Full AEC-Q200 qualification applies only to European Part Numbers at ohmic values ≥R01.

### **Ordering Procedure**

This product has two valid part numbers:

European (Welwyn) Part Number: LRF1206-R02FW (1206, 20 milliohms ±1%, Pb-free)



1	2	3	4	5 Termination & Packing			
Туре	Size	Value	Tolerance				
LR = Conventional orientation (values >R025)	1206 E24 = 3/4		F = ±1%	W	Pb-free, standard packing		
	2010	characters	G = ±2%	T1	Pb-free, 1000/reel (non-standard		
LRF = Flip-chip orientation	2512	R = ohms	$J = \pm 5\%$	PB	SnPb finish, standard packing		
(values ≤R025)				,	Standard	packing is tape & reel	
				120	6 & 2010	3000/reel	
					2512	1800/reel	

USA (IRC) Part Number: LRC-LRF1206LF-01-R020-F (1206, 20 milliohms ±1%, Pb-free)



1 Family	2 Model	3 Size	4 Termination	5 TCR	6 Value	7 Tolerance		Packing	
LRC	LR = Conventional orientation (values >R025)	1206 2010	Omit for SnPb LF = Pb-free	01 = standard (±100ppm/°C		$F = \pm 1\%$ $G = \pm 2\%$	Standard pa	acking is ta	pe & reel
	LRF = Flip-chip orientation (values ≤R025)	2512		values ≥R05)		J = ±5%	1206 & 2010	3000/reel 1800/reel	Standard
							2512	1000/reel	Non- standard

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IGMF1R00C ERJ-1GMF1R20C ERJ-1GMF2R55C ERJ-1GMF8R66C 25121WF1003T4E 25.501.3653.0 290-1.0M-RC 292
2.2K-RC 292-4.7K-RC 25121WF4700T4E 292-470K-RC 302-1.0M-RC CPG1206F10KC CRCW02011R00FXED CRCW060315K0FKEE

CRCW060320K5FKEE CRG0201F10K RCG0402150RFKED RCG04023K92FKED RCP2512B100RGWB RCWP110010R0FKS3

RCWP11002K00FKS3 RCWP12061K00FKS2 3520510RJT 352075KJT M55342K11B9E53RUL RMC16-102JT RMC1JPTE TR0603MR
075K1L 5-2176094-4 35202K7JT WF06Q1000FTL ERJ-S03J1R0V ERJ-S14J4R7U CHP2512L4R30GNT CPCC10270R0JE32

RCWP11001K00FKS3